TOSHIBA Photocoupler GaAs IRED & Photo-Transistor

# **TLP781,TLP781F**

Office Equipment Household Appliances Solid State Relays Switching Power Supplies Various Controllers Signal Transmission Between Different Voltage Circuits

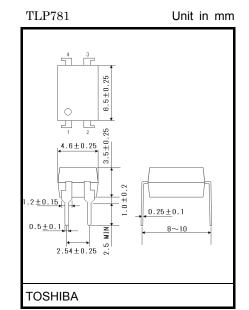
The TOSHIBA TLP781 consists of a silicone photo-transistor optically coupled to a gallium arsenide infrared emitting diode in a four lead plastic DIP (DIP4) with having high isolation voltage (AC: 5kVRMS (min)).

- TLP781 : 7.62mm pitch type DIP4
- TLP781F: 10.16mm pitch type DIP4
- Collector-emitter voltage: 80V (min.)
- Current transfer ratio: 50% (min.) Rank GB: 100% (min.)
- Isolation voltage: 5000V<sub>rms</sub> (min.)
- UL recognized: UL1577, file No. E67349
- BSI approved: BS EN60065:2002 Approved no.8961
  - BS EN60950-1:2006
  - Approved no.8962
  - SEMKO approved:EN60065:2002 Approved no.800514 EN60950-1:2001, EN60335-1:2002 Approved no.800517
- Option(D4)type VDE approved : DIN EN60747-5-2 Certificate No. 40021173

(Note): When an EN60747-5-2 approved type is needed, Please designate "Option (D4)"

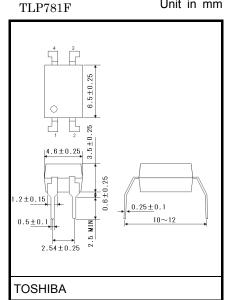
Construction mechanical rating

	7.62mm Pitch Standard Type	10.16mm Pitch TLPxxxF Type
Creepage distance	6.5mm(min)	8.0mm(min)
Clearance	6.5mm(min)	8.0mm(min)
Insulation thickness	0.4mm(min)	0.4mm(min)



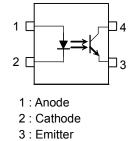
#### Weight: 0.25g (typ.)

Unit in mm



Weight: 0.25g (typ.)

#### **Pin Configurations** (top view)



4 : Collector

#### **Current Transfer Ratio**

Туре	Classi– fication (Note 1)	Current Transfer Ratio (%)           (I <sub>C</sub> / I <sub>F</sub> )           I <sub>F</sub> = 5mA, V <sub>CE</sub> = 5V, Ta = 25°C           Min         Max		Marking Of Classification
	(None)	50	600	Blank, Y, Y+, YE,G, G+, B, B+,BL,GB
	Rank Y	50	150	YE
	Rank GR	100	300	GR
	Rank BL	200	600	BL
TLP781	Rank GB	100	600	GB
	Rank YH	75	150	Y+
	Rank GRL	100	200	G
	Rank GRH	150	300	G+
	Rank BLL	200	400	В

(Note 1): Ex. rank GB: TLP781 (GB)

(Note 2): Application type name for certification test, please use standard product type name, i. e. TLP781 (GB): TLP781

#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristic		Symbol	Rating	Unit
	Forward current		lF	60	mA
	Forward current derating (Ta ≥ 39°C)		ΔI <sub>F</sub> / °C	-0.7	mA / °C
	Pulse forward current	(Note 3)	I <sub>FP</sub>	1	А
ĒD	Power dissipation		PD	100	mW
	Power dissipation derating		ΔP <sub>D</sub> / °C	-1.0	mW / °C
	Reverse voltage		V <sub>R</sub>	5	V
	Junction temperature		Tj	125	°C
	Collector-emitter voltage		V <sub>CEO</sub>	80	V
	Emitter-collector voltage		V <sub>ECO</sub>	7	V
for	Collector current		Ι <sub>C</sub>	50	mA
Detector	Power dissipation (single circuit)		PC	150	mW
	Power dissipation derating $(Ta \ge 25^{\circ}C)(single circuit)$		ΔP <sub>C</sub> / °C	-1.5	mW / °C
	Junction temperature		Тj	125	°C
Ope	rating temperature range		T <sub>opr</sub>	-55 to 110	°C
Stor	age temperature range		T <sub>stg</sub>	-55 to 125	°C
Lea	d soldering temperature (10s)		T <sub>sol</sub>	260	°C
Tota	I package power dissipation		PT	250	mW
	Il package power dissipation derating ≥ 25°C)		ΔP <sub>T</sub> / °C	-2.5	mW / °C
Isola	ation voltage	(Note 4)	BVS	5000	V <sub>rms</sub>

(Note): Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 3): 100 µs pulse, 100 Hz frequency

(Note 4): AC, 1 min., R.H.≤ 60%. Apply voltage to LED pin and detector pin together.

#### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	V <sub>CC</sub>	_	5	24	V
Forward current	١ <sub>F</sub>	-	16	25	mA
Collector current	Ι <sub>C</sub>	-	1	10	mA
Operating temperature	T <sub>opr</sub>	-25	_	85	°C

(Note): Recommended operating conditions are given as a design guideline

to obtain expected performance of the device.

Additionally, each item is an independent guideline respectively.

In developing designs using this product, please confirm

specified characteristics shown in this document.

#### Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	-	_	10	μA
	Capacitance	CT	C <sub>T</sub> V = 0, f = 1 MHz		30	_	pF
	Collector–emitter breakdown voltage	V <sub>(BR)</sub> CEO	I <sub>C</sub> = 0.5 mA	80	_		V
2	Emitter-collector breakdown voltage	V <sub>(BR) ECO</sub>	I <sub>E</sub> = 0.1 mA	7	_	_	V
Detector	Collector dark ourrent	1-(1)	V <sub>CE</sub> = 24 V	_	0.01	0.1	μA
	Collector dark current	ID(ICEO)	V <sub>CE</sub> = 24 V Ta = 85°C	_	0.6	50	μA
	Capacitance (collector to emitter)	C <sub>CE</sub>	V = 0, f = 1 MHz	_	10	_	pF

#### Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition		Min	Тур.	Max	Unit
Current transfer ratio	I <sub>C</sub> / I <sub>F</sub>	I <sub>F</sub> = 5 mA, V <sub>CE</sub> = 5 V		50		600	%
			Rank GB	100		600	70
Saturated CTR	I <sub>C</sub> / I <sub>F (sat)</sub>	IF = 1 mA, V <sub>CE</sub> = 0.4 V		-	60		%
	IC / IF (sat)		Rank GB	30	-	-	70
		$I_{C}$ = 2.4 mA, $I_{F}$ = 8 mA		-	-	0.4	
Collector–emitter saturation voltage	V <sub>CE (sat)</sub>	I <sub>C</sub> = 0.2 mA, I <sub>F</sub> = 1 mA		_	0.2	_	V
Ŭ			Rank GB	_	_	0.4	

#### Isolation Characteristics (Ta = 25°C)

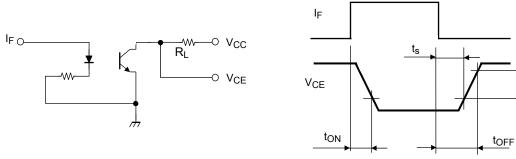
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance (input to output)	CS	V <sub>S</sub> = 0, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
		AC, 1 minute	5000	_	_	V
Isolation voltage	BVS	AC, 1 second, in oil	_	10000	_	V <sub>rms</sub>
		DC, 1 minute, in oil		10000		Vdc

 $V_{CC}$ 4.5V

\_0.5V

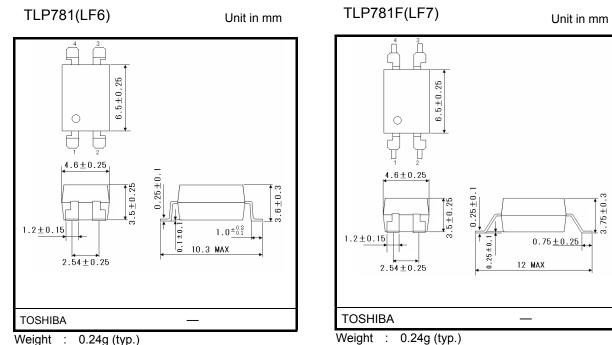
Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Rise time	tr		_	2	_	
Fall time	t <sub>f</sub>	V <sub>CC</sub> = 10 V, I <sub>C</sub> = 2 mA	_	3	_	
Turn–on time	t <sub>on</sub>	R <sub>L</sub> = 100Ω	_	3	_	μs
Turn-off time	t <sub>off</sub>		_	3	_	
Turn–on time	t <sub>ON</sub>		_	2	_	
Storage time	ts	$R_L = 1.9 kΩ$ (Note 5) V <sub>CC</sub> = 5 V, I <sub>F</sub> = 16 mA	_	25	_	μs
Turn-off time	tOFF		_	50	_	



(Note 5): Switching time test circuit

#### **Surface-Mount Lead Form Options**



Weight : 0.24g (typ.)

### Specifications for Embossed-Tape Packing: (TP6), (TP7)

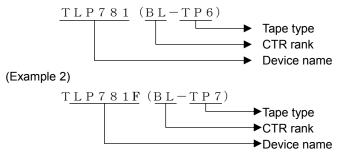
#### 1. Applicable Package

Package Name	Product Type
DIP4LF6	TLP781
DIP4LF7	TLP781F

#### 2. Product Naming System

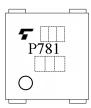
Type of package used for shipment is denoted by a symbol suffix after a product number. The method of classification is as below.

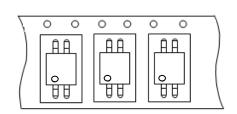
(Example 1)



#### 3. Tape Dimensions

3.1 Orientation of Device in Relation to Direction of Tape Movement Device orientation in the recesses is as shown in Figure 1.





Tape feed 🔿

**Figure1 Device Orientation** 

- 3.2 Tape Packing Quantity:2000 devices per reel
- 3.3 Empty Device Recesses Are as Shown in Table 1.

**Table1 Empty Device Recesses** 

	Standard	Remarks
Occurrences of 2 or more successive empty device recesses	0	Within any given 40-mm section of tape, not including leader and trailer
Single empty device recesses	6 devices (max.) per reel	Not including leader and trailer

3.4 Start and End of Tape

The start of the tape has 30 or more empty holes. The end of the tape has 50 or more empty holes.

#### 3.5 Tape Specification

[1] TLP781 (TP6)

(1)Tape material: Plastic

(2)Dimensions: The tape dimensions are as shown in Figure 2.

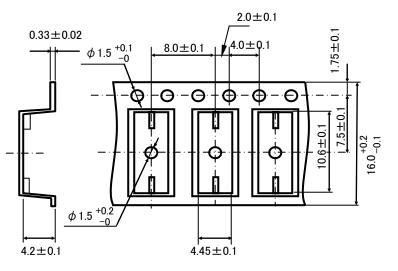
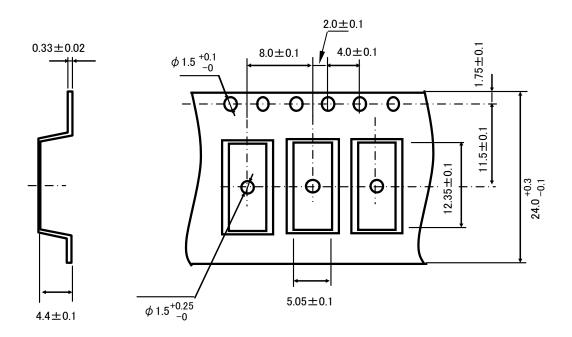


Figure 2 Tape Forms

#### [2] TLP781F (TP7)

(1)Tape material: Plastic

(2)Dimensions: The tape dimensions are as shown in Figure 3.



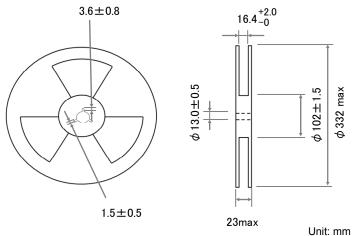


#### 3.6 Reel Specification

[1] TLP781 (TP6)

(1)Material: Plastic

(2)Dimensions: The reel dimensions are as shown in Figure 4.

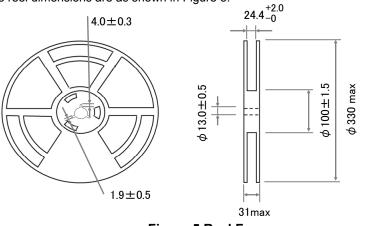


#### Figure 4 Reel Forms

#### [2] TLP781F (TP7)

(1)Material: Plastic

(2)Dimensions: The reel dimensions are as shown in Figure 5.



#### Figure 5 Reel Forms

#### 4. Packing

One reel of photocouplers is packed in a shipping carton.

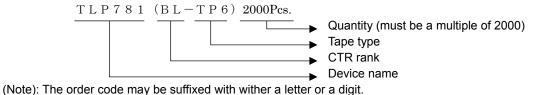
#### 5. Label Indication

The carton bears a label indicating the product number, the symbol representing classification of standard, the quantity, the lot number and the Toshiba company name.

#### 6. Ordering Information

When placing an order, please specify the product number, the CTR rank, the tape type and the quantity as shown in the following example.

(Example)



Please contact your nearest Toshiba sales representative for more details.

### Soldering and Storage

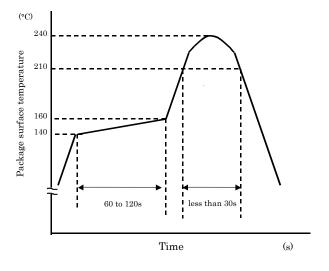
#### 1. Soldering

1.1 Soldering

When using a soldering iron or medium infrared ray/hot air reflow, avoid a rise in device temperature as much as possible by observing the following conditions.

1) Using solder reflow

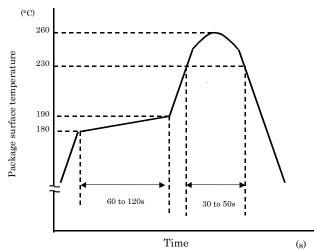
·Temperature profile example of lead (Pb) solder



This profile is based on the device's maximum heat resistance guaranteed value.

Set the preheat temperature/heating temperature to the optimum temperature corresponding to the solder paste type used by the customer within the described profile.

·Temperature profile example of using lead (Pb)-free solder



This profile is based on the device's maximum heat resistance guaranteed value.

Set the preheat temperature/heating temperature to the optimum temperature corresponding to the solder paste type used by the customer within the described profile.

2) Using solder flow (for lead (Pb) solder, or lead (Pb)-free solder)

Please preheat it at 150°C between 60 and 120 seconds.

• Complete soldering within 10 seconds below 260°C. Each pin may be heated at most once.

3) Using a soldering iron

Complete soldering within 10 seconds below 260°C, or within 3 seconds at 350°C. Each pin may be heated at most once.

#### 2. Storage

- 1) Avoid storage locations where devices may be exposed to moisture or direct sunlight.
- 2) Follow the precautions printed on the packing label of the device for transportation and storage.

3) Keep the storage location temperature and humidity within a range of 5°C to 35°C and 45% to 75%, respectively.

- 4) Do not store the products in locations with poisonous gases (especially corrosive gases) or in dusty conditions.
- 5) Store the products in locations with minimal temperature fluctuations. Rapid temperature changes during storage can cause condensation, resulting in lead oxidation or corrosion, which will deteriorate the solderability of the leads.
- 6) When restoring devices after removal from their packing, use anti-static containers.
- 7) Do not allow loads to be applied directly to devices while they are in storage.
- 8) If devices have been stored for more than two years under normal storage conditions, it is recommended that you check the leads for ease of soldering prior to use.

#### **EN60747** Isolation Characteristics

#### Types: TLP781, TLP781F

Type designations for 'option: (D4) ', which are tested under EN60747 requirements.Ex.: TLP781 (D4-GR-LF6)D4: EN60747 option

GR: CTR rank name LF6: standard lead bend name

Note: Use TOSHIBA standard type number for safety standard application. Ex. TLP781 (D4-GR-LF6)  $\rightarrow$  TLP781

Description	Symbol	Rating	Unit
Application classification			
for rated mains voltage $\leq$ 300 V <sub>rms</sub> for rated mains voltage $\leq$ 600 V <sub>rms</sub>		I–IV I–III	_
Climatic classification		55 / 115 / 21	_
Pollution degree		2	—
Maximum operating insulation voltage	VIORM	890	Vpk
Input to output test voltage, Vpr = 1.5×V <sub>IORM</sub> , type and sample test t <sub>p</sub> = 10s, partial discharge < 5pC	V <sub>pr</sub>	1335	Vpk
Input to output test voltage, Vpr = 1.875×V <sub>IORM</sub> , 100% production test t <sub>p</sub> = 1s, partial discharge < 5pC	V <sub>pr</sub>	1670	Vpk
Highest permissible overvoltage (transient overvoltage, t <sub>pr</sub> = 60s)	V <sub>TR</sub>	6000	Vpk
Safety limiting values (max. permissible ratings in case of fault) fault) current (input current I <sub>F</sub> , P <sub>Si</sub> = 0) power (output or total power dissipation) temperature	I <sub>si</sub> P <sub>si</sub> T <sub>si</sub>	300 500 150	mA mW °C
Insulation resistance, V <sub>IO</sub> = 500V,Ta=25°C	Rsi	≥10 <sup>12</sup>	Ω

#### **Insulation Related Specifications**

		7.62mm pitch TLPxxx type	10.16mm pitch TLPxxxF type	
Minimum creepage distance	Cr	6.5mm	8.0mm	
Minimum clearance	CI	6.5mm	8.0mm	
Minimum insulation thickness	ti	0.4 mm		
Comparative tracking index	СТІ	175		

- (1) If a printed circuit is incorporated, the creepage distance and clearance may be reduced below this value. (e.g.at a standard distance between soldering eye centres of 7.5mm). If this is not permissible, the user shall take suitable measures.
- (2) This photocoupler is suitable for 'safe electrical isolation' only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuits.

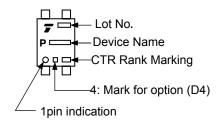
4

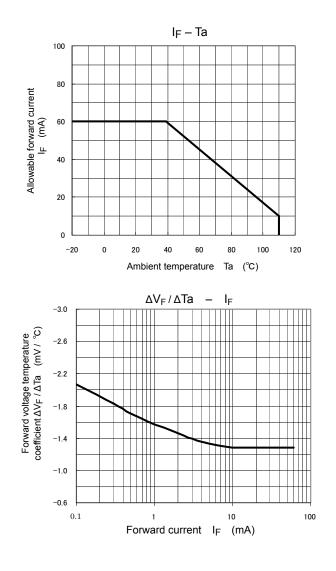
VDE test sign: Marking on product for EN60747

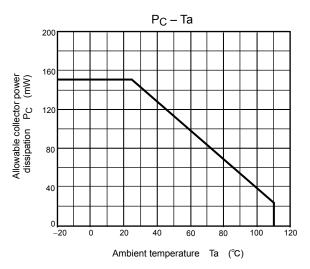
Marking on packing for EN60747

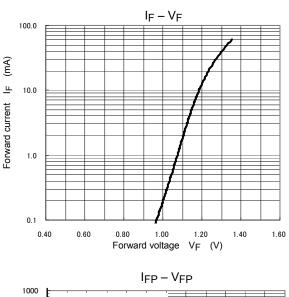


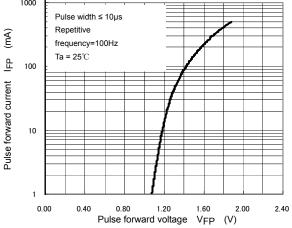
Marking Example: TLP781, TLP781F



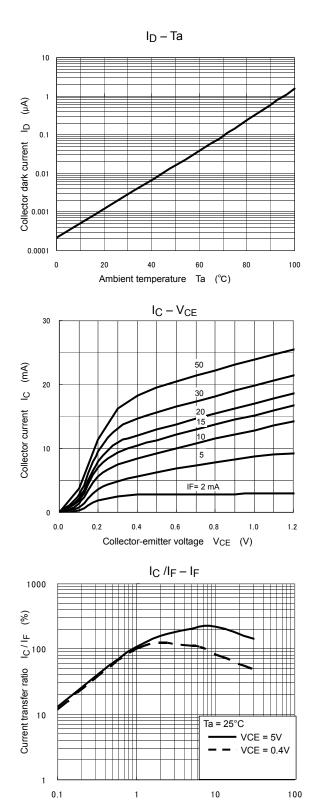




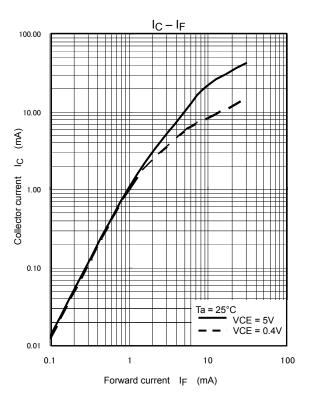




\*: The above graphs show typical characteristics.

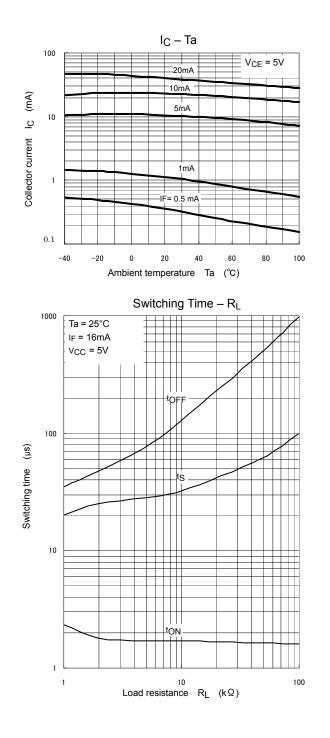


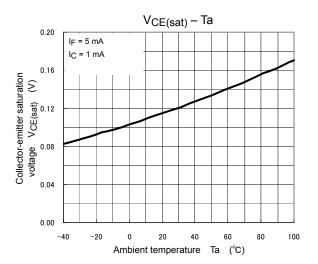
 $I_{C} - V_{CE}$ 80 (mA) 60 Collector current IC 50 40 20 20 IF= 2 mA 0 0 2 4 6 8 10 Collector-emitter voltage  $V_{CE}$  (V)



\*: The above graphs show typical characteristics.

Forward current IF (mA)





 $\ast :$  The above graphs show typical characteristics.

#### **RESTRICTIONS ON PRODUCT USE**

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before creating and producing designs and using, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application that Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- Product is intended for use in general electronics applications (e.g., computers, personal equipment, office equipment, measuring equipment, industrial robots and home electronics appliances) or for specific applications as expressly stated in this document. Product is neither intended nor warranted for use in equipment or systems that require extraordinarily high levels of quality and/or reliability and/or a malfunction or failure of which may cause loss of human life, bodily injury, serious property damage or serious public impact ("Unintended Use"). Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. Do not use Product for Unintended Use unless specifically permitted in this document.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without
  limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile
  technology products (mass destruction weapons). Product and related software and technology may be controlled under the
  Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product
  or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. TOSHIBA assumes no liability for damages or losses occurring as a result of noncompliance with applicable laws and regulations.

### **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Transistor Output Optocouplers category:

Click to view products by Toshiba manufacturer:

Other Similar products are found below :

LTV-814S-TA LTV-824HS 66095-001 6N136-X017T MCT6-X007 MOC8101-X017T PS2561A-1-W-A PS2561B-1-L-A PS2561L-1-V-A MRF658 IL755-1X007 ILD2-X006 ILD74-X001 ILQ615-2X017 ILQ615-3X016 LDA102S LDA110S PS2561-1-V-W-A PS2561AL-1-V-A PS2561L1-1-L-A PS2701A-1-F3-P-A PS2801-1-F3-P-A PS2911-1-L-AX CNY17-2X017 CNY17-4X001 CNY17-4X017 CNY17F-1X007 CNY17F-2X017 CNY17F-4X001 CNY17G-1 LTV-214 LTV-702VB LTV-733S LTV-816S-TA LTV-825S TCET1113 TCET2100 4N25-X007T IL215AT ILD615-1X007 ILQ2-X007 VOS615A-2T WPPC-A11066AA WPPC-A11066AD WPPC-A11084ASS WPPC-A21068AA WPPC-D11066AA WPPC-D21068ED WPPC-D410616EA WPPC-D410616ED